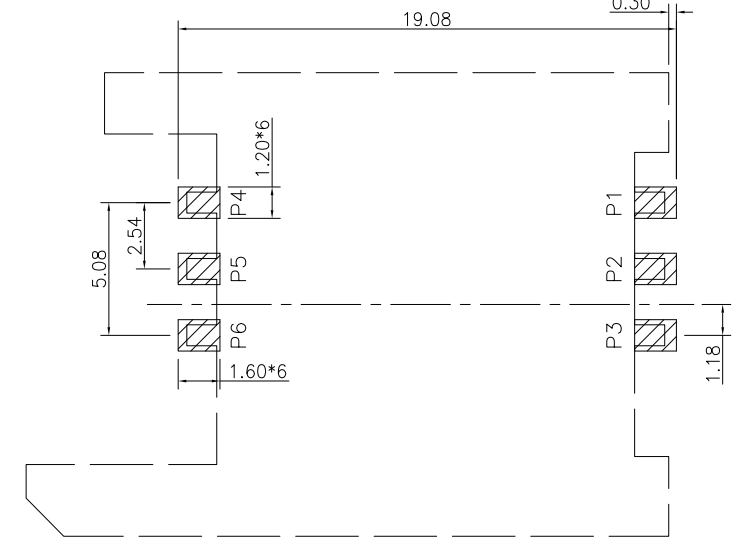
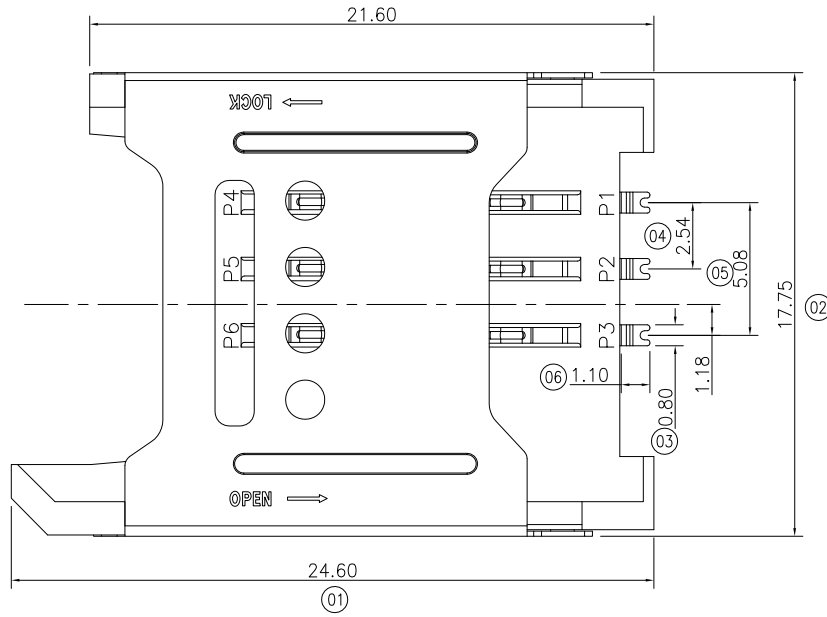
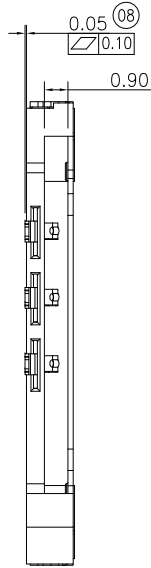
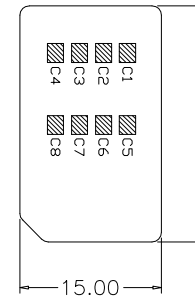
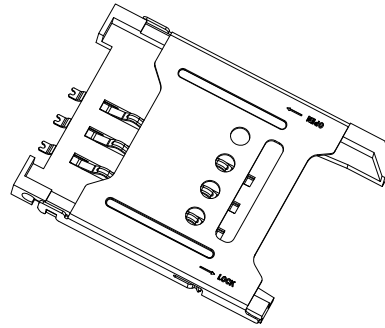
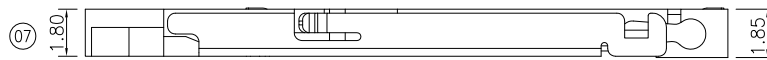


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
AO			Initial	2016/08/05	Phebe Su
A1			Change	2017/02/20	Phebe Su



RECOMMEND PCB LAYOUT
TOLERANCE: +/ - 0.05 (TOP VIEW)



SIM CARD

PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C2:RST
P3#	C3:CLK
P4#	C5:GND
P5#	C6:VPP
P6#	C7:I/O

NOTE:

1.材质

塑胶:LCP BLACK

端子:磷铜 C5190-EH T=0.15+/-0.01mm

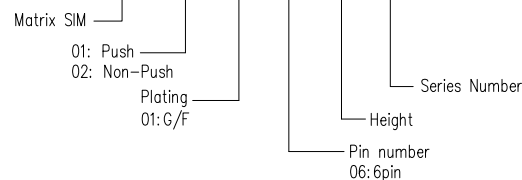
铁壳:不锈钢 SUS301-1/4H T=0.20+/-0.01mm



2.电镀:

端子:Gold flash 30u''Ni 80u''Sn

MATRIX PART NO:

MSM - 02 - 01 - 06 - 18 - 20



NO	VARIETY	QTY	MATERIAL	REMARK
 Matrix Electronics Co.,Ltd				
TOLERANCE: X.X ±0.35 X.XX ±0.25 X.XXX ±0.15 ANGLE: ±3°		DESIGN BY : Phebe Su	DATE : 2017/02/20	PART NAME: SIM CARD 6P 1.8H
 UNIT: mm [inch] SCALE: 1:1 SIZE: A4		CHECKED BY: Vicky Hsieh	DATE : 2017/02/20	PART NO. MSM-02-01-06-18-20
		APPROVED BY1: Richard Hsieh	DATE : 2017/02/20	MOLD NO. NA
		APPROVED BY2: Richard Hsieh	DATE : 2017/02/20	DRAW NO. SHEET NO. 1 OF 1